# **OSRAM** LT L29S **Datasheet**

Discontinued





### SMARTLED® 0603

## **LT L29S**

The innovative SMARTLED 0603 joins the successful family of TOPLED. Invested with the same high quality, its unique features are due to set new standards in product development and design, opening up new applications on a new scale.





#### **Applications**

- Access Control & Security
- Appliances & Tools
- Factory Automation
- Home & Building Automation

- Material Processing
- Projection & Display
- Robotics

#### **Features**

- Package: SMT package 0603, colorless diffused resin
- Chip technology: InGaN
- Typ. Radiation: 155° (horizontal), 135° (vertical)
- Color: λ<sub>dom</sub> = 528 nm (• true green)
- Optical efficacy: 7 lm/W
- Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101-REV-C, Stress Test Qualification for Automotive Grade Discrete Semiconductors.
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)

7	
ă	
ч	4
Ξ	
7	
$\succeq$	

Ordering Information				
Туре	Luminous Intensity 1)  I <sub>F</sub> = 10 mA  I <sub>V</sub>	Ordering Code		
LT L29S-N1R2-25	28.0 180.0 mcd	Q65112A9879		
LT L29S-N2Q1-25	35.5 90.0 mcd	Q65112A9878		
LT L29S-P2R1-25	56.0 140.0 mcd	Q65112A9877		

7	3
ă	ט
i	2
2	
t	Ĕ
ē	5
Š	Š
2	2
	1

Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	$T_{op}$	min. max.	-40 °C 100 °C
Storage Temperature	$T_{stg}$	min. max.	-40 °C 100 °C
Junction Temperature	T <sub>j</sub>	max.	100 °C
Forward current T <sub>A</sub> = 25 °C	I <sub>F</sub>	max.	15 mA
Surge current t $\leq$ 10 $\mu$ s; D = 0.005 ; T <sub>A</sub> = 25 °C	I <sub>FS</sub>	max.	150 mA
Reverse voltage <sup>2)</sup> T <sub>A</sub> = 25 °C	$V_R$	max.	5 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	$V_{ESD}$		2 kV

## **Characteristics**

 $I_F = 10 \text{ mA}; T_A = 25 \text{ }^{\circ}\text{C}$ 

Parameter	Symbol		Values
Peak Wavelength	$\lambda_{peak}$	typ.	523 nm
Dominant Wavelength 3)	$\lambda_{\sf dom}$	min.	517 nm
$I_{\rm F} = 10 \text{ mA}$	dom	typ.	528 nm
		max.	541 nm
Spectral Bandwidth at 50% I <sub>rel,max</sub>	Δλ	typ.	33 nm
Viewing angle at 50% I <sub>v</sub>	2φ	typ.	155 °
values for 0°, 90°		typ.	135 °
Forward Voltage 4)	V <sub>F</sub>	typ.	3.40 V
$I_F = 10 \text{ mA}$	·	max.	3.80 V
Reverse current <sup>2)</sup>	I <sub>R</sub>	typ.	0.01 μΑ
$V_R = 5 V$		max.	10 µA
Temperature Coefficient of Peak Wavelength -10°C ≤ T ≤ 100°C	$TC_{\lambda peak}$	typ.	0.04 nm / K
Temperature Coefficient of Dominant Wavelength -10°C ≤ T ≤ 100°C	$TC_{\lambda dom}$	typ.	0.04 nm / K
Temperature Coefficient of Forward Voltage -10°C ≤ T ≤ 100°C	$TC_{VF}$	typ.	-3.6 mV / K
Real thermal resistance junction/ambient 5)6)	$R_{ ext{thJA real}}$	max.	450 K / W
Real thermal resistance junction/solderpoint 5)	R <sub>thJS real</sub>	max.	260 K / W



## **Brightness Groups**

Group	Luminous Intensity <sup>1)</sup> I <sub>F</sub> = 10 mA	Luminous Intensity. 1) I <sub>F</sub> = 10 mA	Luminous Flux <sup>7)</sup> I <sub>F</sub> = 10 mA
	min. I <sub>v</sub>	max. I <sub>v</sub>	typ. Φ <sub>V</sub>
N1	28.0 mcd	35.5 mcd	127.0 mlm
N2	35.5 mcd	45.0 mcd	161.0 mlm
P1	45.0 mcd	56.0 mcd	202.0 mlm
P2	56.0 mcd	71.0 mcd	254.0 mlm
Q1	71.0 mcd	90.0 mcd	322.0 mlm
Q2	90.0 mcd	112.0 mcd	404.0 mlm
R1	112.0 mcd	140.0 mcd	504.0 mlm
R2	140.0 mcd	180.0 mcd	640.0 mlm

## **Wavelength Groups**

Group	Dominant Wavelength $^{3)}$ $I_F = 10 \text{ mA}$ min. $\lambda_{\text{dom}}$	Dominant Wavelength $^{3)}$ $I_F = 10 \text{ mA}$ $max.$ $\lambda_{dom}$	
2	517 nm	523 nm	
3	523 nm	529 nm	
4	529 nm	535 nm	
5	535 nm	541 nm	



## **Group Name on Label**

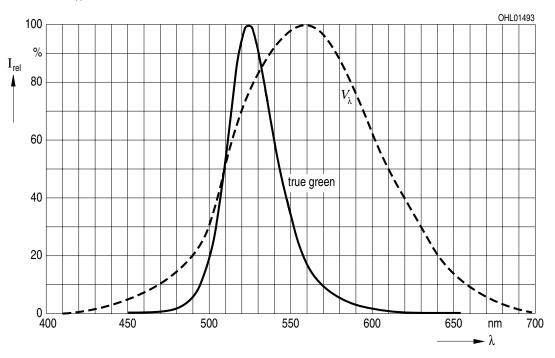
Example: N1-2

Brightness Wavelength

N1 2

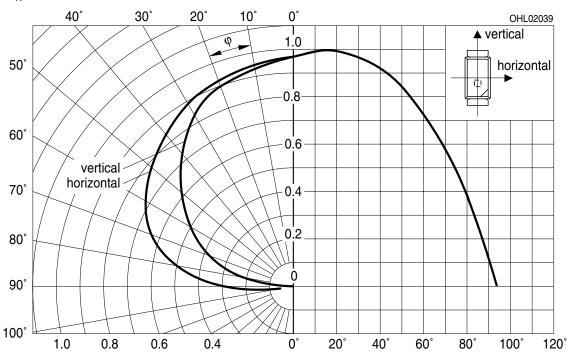
## Relative Spectral Emission 7)

 $I_{rel}$  = f ( $\lambda$ );  $I_F$  = 10 mA;  $T_A$  = 25 °C



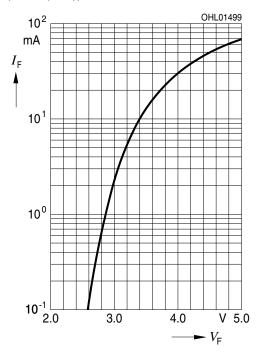
## Radiation Characteristics 7)

 $I_{rel} = f(\phi); T_A = 25 °C$ 



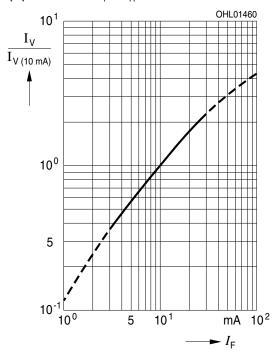
#### Forward current 7)

$$I_F = f(V_F); T_A = 25 °C$$



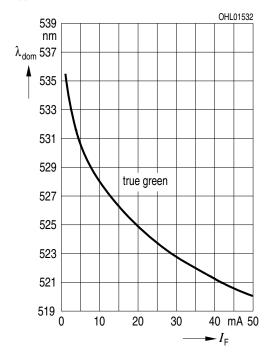
## Relative Luminous Intensity 7), 8)

$$I_{v}/I_{v}(10 \text{ mA}) = f(I_{F}); T_{A} = 25 \text{ °C}$$



## Dominant Wavelength 7)

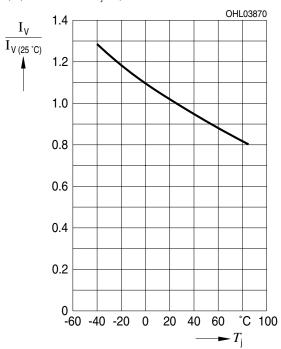
$$\lambda_{dom} = f(I_F); T_A = 25 \text{ }^{\circ}\text{C}$$





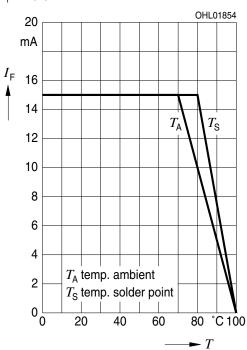
## Relative Luminous Intensity 7)

 $I_{v}/I_{v}(25 \text{ °C}) = f(T_{j}); I_{F} = 10 \text{ mA}$ 



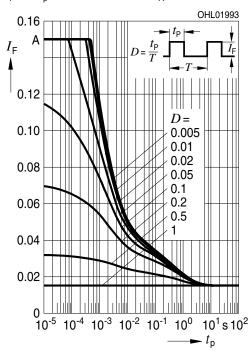
#### Max. Permissible Forward Current





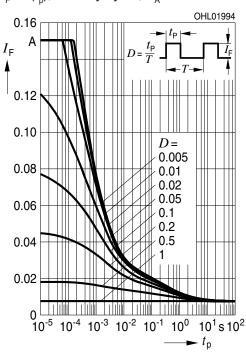
## Permissible Pulse Handling Capability

 $I_{_{\rm F}}$  = f(t $_{_{
m p}}$ ); D: Duty cycle;  $T_{_{
m A}}$  = 25 °C

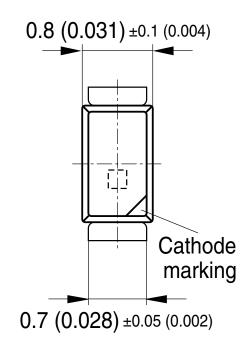


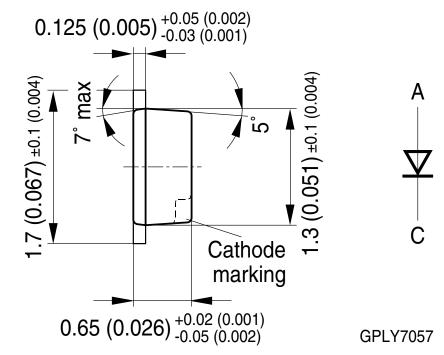
## Permissible Pulse Handling Capability

 $I_{_F}$  = f(t $_{_D}$ ); D: Duty cycle;  $T_{_A}$  = 85 °C



## **Dimensional Drawing** 9)





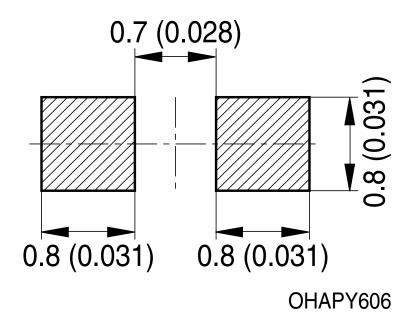
#### **Further Information:**

**Approximate Weight:** 1.6 mg

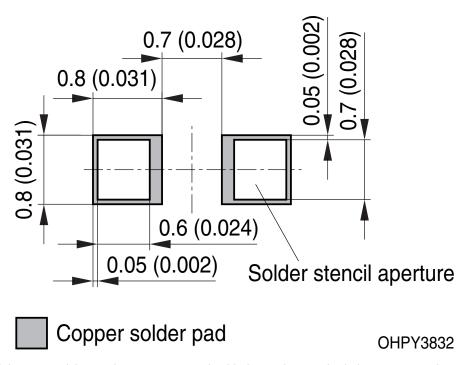
Package marking: Cathode



#### Recommended Solder Pad 9)



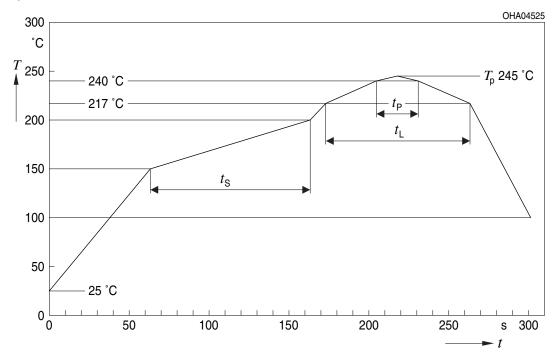
#### Recommended Solder Pad 9)



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere.

## **Reflow Soldering Profile**

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

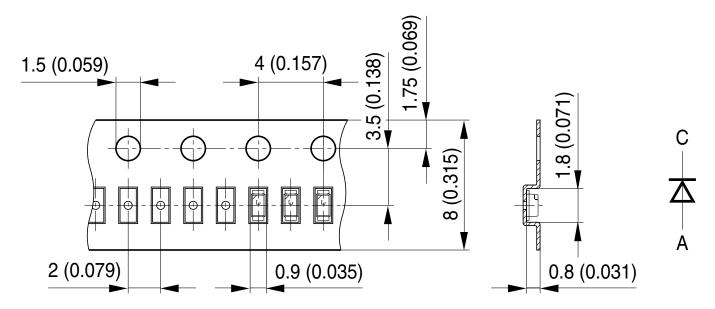


Profile Feature	Symbol	Pb	-Free (SnAgCu) Ass	sembly	Unit
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*) 25 °C to 150 °C			2	3	K/s
Time $t_s$ $T_{smin}$ to $T_{smax}$	t <sub>s</sub>	60	100	120	S
Ramp-up rate to peak $^{*)}$ T <sub>Smax</sub> to T <sub>P</sub>			2	3	K/s
Liquidus temperature	$T_{L}$		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle L}$		80	100	S
Peak temperature	T <sub>P</sub>		245	260	°C
Time within 5 °C of the specified peak temperature T <sub>P</sub> - 5 K	t <sub>P</sub>	10	20	30	S
Ramp-down rate* T <sub>P</sub> to 100 °C			3	6	K/s
Time 25 °C to T <sub>P</sub>				480	S

All temperatures refer to the center of the package, measured on the top of the component

 $<sup>^{\</sup>star}$  slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

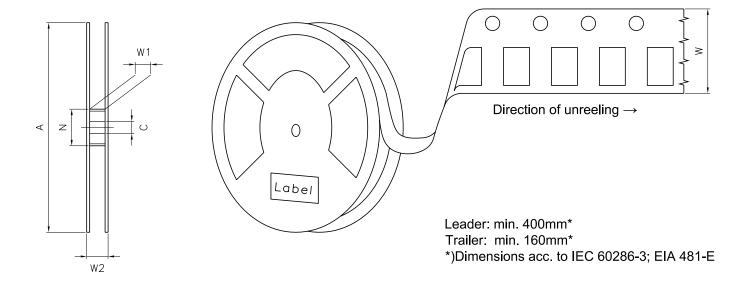
## Taping 9)



**OHAY1491** 



## Tape and Reel 10)



#### **Reel Dimensions**

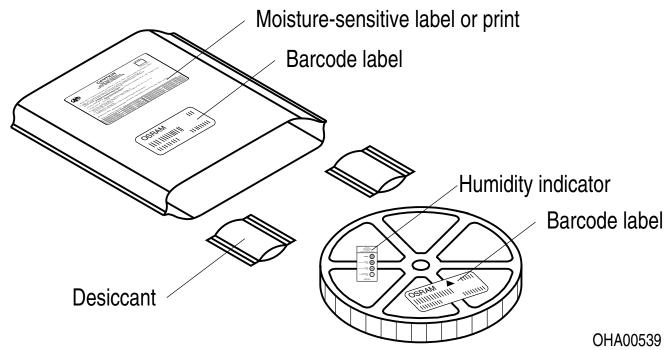
Α	W	$N_{min}$	$W_1$	$W_{2 max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	5000



#### **Barcode-Product-Label (BPL)**



## Dry Packing Process and Materials 9)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.

#### **Notes**

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class exempt group (exposure time 10000 s). Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes

#### **Disclaimer**

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

#### **Packing**

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

#### Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

#### Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ±8 % and an expanded uncertainty of ±11 % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k =
- 4) Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ±0.05 V and an expanded uncertainty of ±0.1 V (acc. to GUM with a coverage factor of k = 3).
- 5) **Thermal Resistance:** Rth max is based on statistic values  $(6\sigma)$ .
- 6) Thermal Resistance: RthJA results from mounting on PC board FR 4 (pad size ≥ 5 mm² per pad)
- 7) Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- Characteristic curve: In the range where the line of the graph is broken, you must expect higher differ-8) ences between single devices within one packing unit.
- 9) Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- Tape and Reel: All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.

	_	5
	ă	í
	v	
	=	
	⋍	
۰	Ħ	
	늘	
	۹	
	9	2
į	_	ı

Revision	Revision History				
Version	Date	Change			
1.2	2019-11-14	Additional Information			
1.3	2020-03-18	Schematic Transportation Box Dimensions of Transportation Box Not for new design removed			
1.4	2022-11-17	Discontinued			

#### Discontinued



EU RoHS and China RoHS compliant product 此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准, 不含有毒有害物质或元素。

#### Published by ams-OSRAM AG

Tobelbader Strasse 30, 8141 Premstaetten, Austria Phone +43 3136 500-0 ams-osram.com © All rights reserved



